WHAT IS CLAIMED IS:

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- 1. A method for treating at least one member of a backing element/microarray assembly structure, said method comprising at least one of: (1) depositing a component on said at least one member, (2) extracting a component from said at least one member, (3) surface modifying said at least one member, to treat said at least one member of a backing element/microarray assembly structure.
- 2. The method of Claim 1, wherein said method comprises depositing a component on said at least one member of a backing element/microarray assembly structure and said depositing comprises performing a SiO₂ deposition protocol.
- 3. The method of Claim 1, wherein said method comprises extracting a component from said at least one member of a backing element/microarray assembly structure.
- 4. The method of Claim 3, wherein said method comprises contacting said at least one member of a backing element/microarray assembly structure with at least one of a liquid phase and a vapor phase.
- 5. The method of Claim 4, wherein said component comprises moieties that may adversely affect an array or its reading.
- 6. The method of Claim 5, wherein said moieties are removed at least from a gasket of said backing element/microarray assembly structure.
- 7. The method of Claim 5, wherein said moieties comprise low-melting point monomers or truncated polymers.
- 8. The method of Claim 7, wherein said low-melting point monomers are D4-D20 series linear or cyclic siloxanes.
- 9. The method of Claim 4, wherein said extraction comprises contacting said at least one member of a backing element/microarray assembly structure with at least one solvent to extract said component.

- 10. The method of Claim 9, wherein said at least one solvent is an aqueous solvent.
- 11. The method of Claim 10, wherein said at least one solvent is an organic solvent.
- 12. The method of Claim 11, wherein said organic solvent is a polar organic solvent.
- 13. The method of Claim 12, wherein said polar organic solvent is chosen from alcohols, ketones, trialkyl amines, tributyl amines and cyclic solvents.
- 14. The method of Claim 11, wherein said organic solvent is a non-polar organic solvent.
- 15. The method of Claim 14, wherein said non-polar organic solvent is chosen from aliphatic hydrocarbons, aromatic hydrocarbons, ethers and glymes.
- 16. The method of Claim 1, wherein said method comprises surface modifying said at least one member of a backing element/microarray assembly structure.
- 17. The method of Claim 16, wherein said surface modification comprises contacting said at least one member of a backing element/microarray assembly structure with a plasma.
- 18. The method of Claim 17, wherein said plasma is produced from nitrogen, air, argon, oxygen, nitrous oxide, helium, water vapor, carbon dioxide, methane, and combinations thereof.
- 19. The method of Claim 16, wherein said surface modification comprises contacting said at least one member of a backing element/microarray assembly structure with a gas/air mixture.
- 20. The method of Claim 16, wherein said surface modification comprises contacting said at least one member of a backing element/microarray assembly structure with a plurality of beads.

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21. The method of Claim 16, wherein said surface modification comprises contacting said at least one member of a backing element/microarray assembly structure with at least one form of radiant energy.

- 22. The method of Claim 16, wherein said surface modification comprises exposing said at least one member of a backing element/microarray assembly structure to UV/O₂.
- 23. The method of Claim 16, wherein said surface modification comprises bombarding said at least one member of a backing element/microarray assembly structure with electrons.
- 24. The method of Claim 16, wherein said surface modification comprises contacting said at least one member of a backing element/microarray assembly structure with at least one reactive gas.
- 25. The method of Claim 16, wherein said surface modification comprises:
 - (a) introducing soluble particulates to uncured gasket material,
 - (b) curing said gasket material, and
 - (c) solubalizing said soluble particulates to provide said textured gasket surface.
- 26. The method of Claim 1, wherein said treatment comprises oxidizing at least one surface of said at least one member of a backing element/microarray assembly structure.
- 27. The method of Claim 1, wherein said treatment comprises increasing the hydrophilicity of said at least one member of a backing element/microarray assembly structure.
- 28. The method of Claim 1, wherein said treatment provides a seal about at least elastomeric gasket of said backing element/microarray assembly structure.
- 29. The method of Claim 1, wherein said treatment comprises sequentially contacting said at least one member of a backing element/microarray assembly structure with at least two of: plasma, UV/O₂ and a solvent.
- 30. The method of Claim 1, wherein said contacted member is a substrate.

- 31. The method of Claim 30, wherein said substrate is a backing element substrate.
- 32. The method of Claim 30, wherein said substrate is a microarray substrate.
- 33. The method of Claim 1, wherein said contacted member is a gasket.
- 34. A treated backing element comprising a substrate with a surface bounded by a polymeric gasket, said backing element comprising at least one of: (1) an area comprising a deposited component, (2) an area wherein at least one component has been extracted, and (3) a surface modified area.
- 35. A method of detecting the presence of an analyte in a sample, said method comprising:
- (a) contacting a sample suspected of comprising said analyte with a backing element/microarray assembly structure treated according to Claim 1 under conditions sufficient for binding of said analyte to said ligand on said microarray substrate to occur, wherein said microarray assembly comprises a ligand that specifically binds to said analyte of; and
- (c) detecting the presence of binding complexes on the surface of said microarray assembly to detect the presence of said analyte in said sample.
- 36. A method comprising transmitting data representing a result obtained from a method of claim 35 from a first location to a second location.
- 37. A method comprising receiving a transmitted result of a reading of a microarray obtained according to the method Claim 35.
- 38. A system comprising:
 - (a) a sample suspected of comprising an analyte; and
 - (b) a backing element/microarray assembly structure treated according to Claim 1.

39. A kit comprising:

- (a) at least one member of a backing element/microarray assembly structure treated according to Claim 1; and
 - (b) instructions for using said treated member in an array assay.